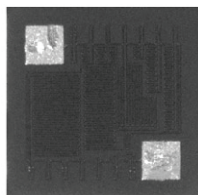


NiCr Thin Film, Top-Contact Resistor



Product may not be to scale

The SFN series resistor chips offer a combination of nichrome stability, good power rating and small size.

The SFNs are manufactured using Vishay Electro-Films (EFI) sophisticated thin film equipment and manufacturing technology. The SFNs are 100 % electrically tested and visually inspected to MIL-STD-883, method 2032, class H or class K.

FEATURES

- Wire bondable
- Chip size: 0.020" square
- Case: 0202
- Resistance range: 20 Ω to 510 k Ω
- Resistor material: Nichrome
- Oxidized silicon substrate
- 125 mW power
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE
GREEN
(5-2008)

APPLICATIONS

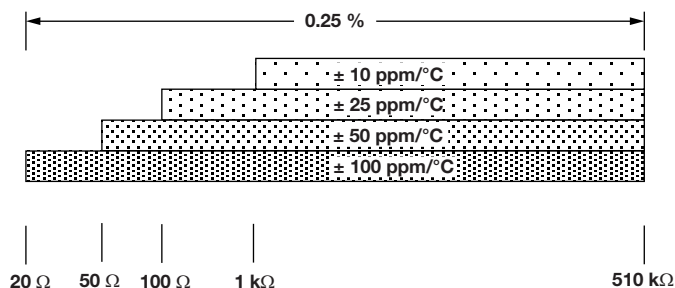
Vishay EFI SFN resistor chips are widely used in hybrid packages where space is limited. Designed with capacity to handle substantial power loads, they also have the benefit of nichrome stability.

Recommended for hermetic environments where die is not exposed to moisture.

TEMPERATURE COEFFICIENT OF RESISTANCE, VALUES, AND TOLERANCES

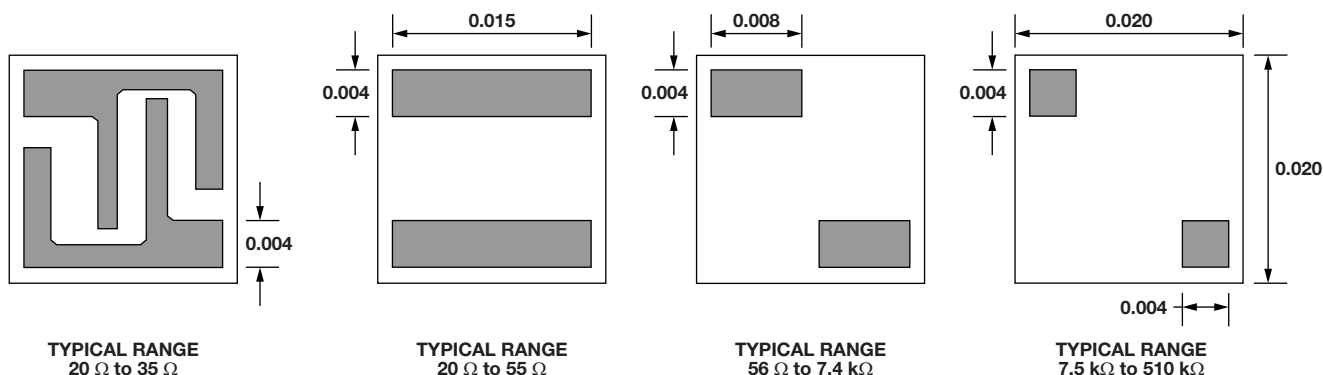
PARAMETER	VALUE	UNIT
Total Resistance Range	20 to 510K	Ω
Standard Tolerances	± 0.25	%
TCR	$\pm 10, \pm 25, \pm 50, \pm 100, \pm 250$	ppm/ $^{\circ}$ C

Tightest Standard Tolerance Available



STANDARD ELECTRICAL SPECIFICATIONS

PARAMETER	VALUE	UNIT
Noise, MIL-STD-202, Method 308 100 Ω to 250 k Ω < 100 Ω or > 251 k Ω	-35 typ. -20 typ.	dB
Stability, 1000 h, +125 $^{\circ}$ C, 50 mW	± 0.25 max. $\Delta R/R$	%
Operating Temperature Range	-55 to +125	$^{\circ}$ C
Thermal Shock, MIL-STD-202, Method 107, Test Condition F	± 0.25 max. $\Delta R/R$	%
High Temperature Exposure, +150 $^{\circ}$ C, 100 h	± 0.5 max. $\Delta R/R$	%
Dielectric Voltage Breakdown	200	V
Insulation Resistance	10^{12} min.	Ω
Operating Voltage	100 max.	V
DC Power Rating at +70 $^{\circ}$ C (Derated to Zero at +175 $^{\circ}$ C)	0.125	W
5 x Rated Power Short-Time Overload, +25 $^{\circ}$ C, 5 s	± 0.25 max. $\Delta R/R$	%

DIMENSIONS in inches

SCHEMATIC

MECHANICAL SPECIFICATIONS

PARAMETER	VALUE
Chip Thickness	0.010" \pm 0.002" (0.254 mm \pm 0.05 mm)
Chip Size	0.020" x 0.020" \pm 0.003" (0.51 mm x 0.51 mm \pm 0.076 mm)
Chip Substrate Material	Oxidized silicon, 10 k \AA minimum SiO ₂
Resistor Material	Nichrome (passivation optional)
Bonding Pad Size	0.004" x 0.004" (0.10 mm x 0.10 mm)
Number of Pads	2
Pad Material	15 k \AA minimum gold (Au optional)
Backing	None, lapped semiconductor silicon (Au back optional)

GLOBAL PART NUMBER INFORMATION

Global Part Number: SFN50000FKANHWS

Global Part Number Description: SFN 5K 1 % 100 ppm Au None H WS

S	F	N	5	0	0	0	0	F	K	A	N	H	W	S
---	---	---	---	---	---	---	---	---	---	---	---	---	---	---

MODEL	RESISTANCE	RESISTANCE MULTIPLIER CODE	TOLERANCE CODE (%)	TCR (ppm/ $^{\circ}$ C)	TERMINATION	BACK METAL	VISUAL CLASS	PACKAGING CODE
SFN 20 x 20 size NiCr on silicon	First 4 digits are significant figures of resistance	B = 0.01 A = 0.1 0 = 1 1 = 10 2 = 100 3 = 1000	C = 0.25 D = 0.5 F = 1.0 G = 2.0 J = 5.0 K = 10	B = \pm 10 E = \pm 25 C = \pm 50 K = \pm 100 M = \pm 250	G = Au A = Al	G = Au N = none	H = class H K = class K	WS = waffle pack 100 min., 1 mult. FW = full wafer



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.